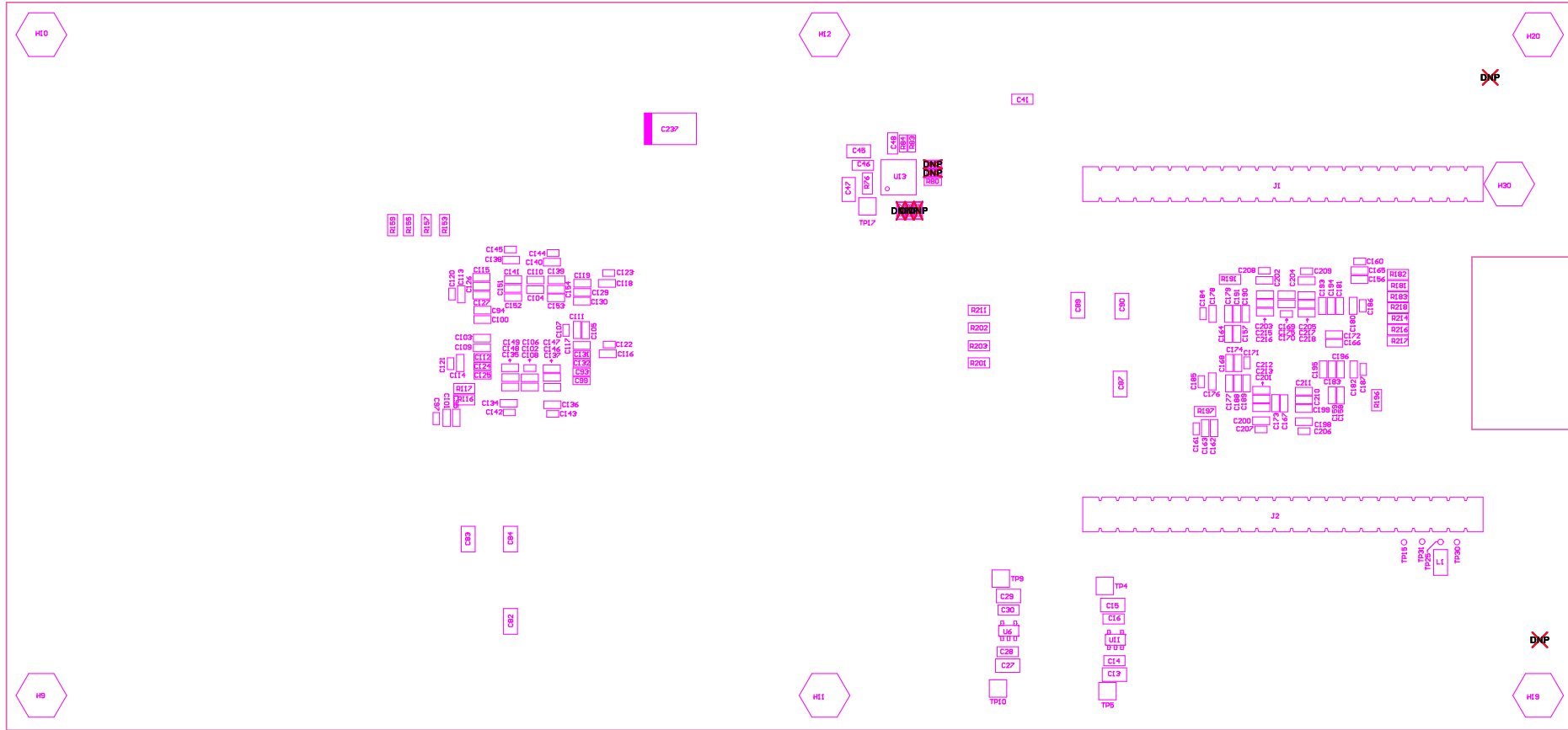


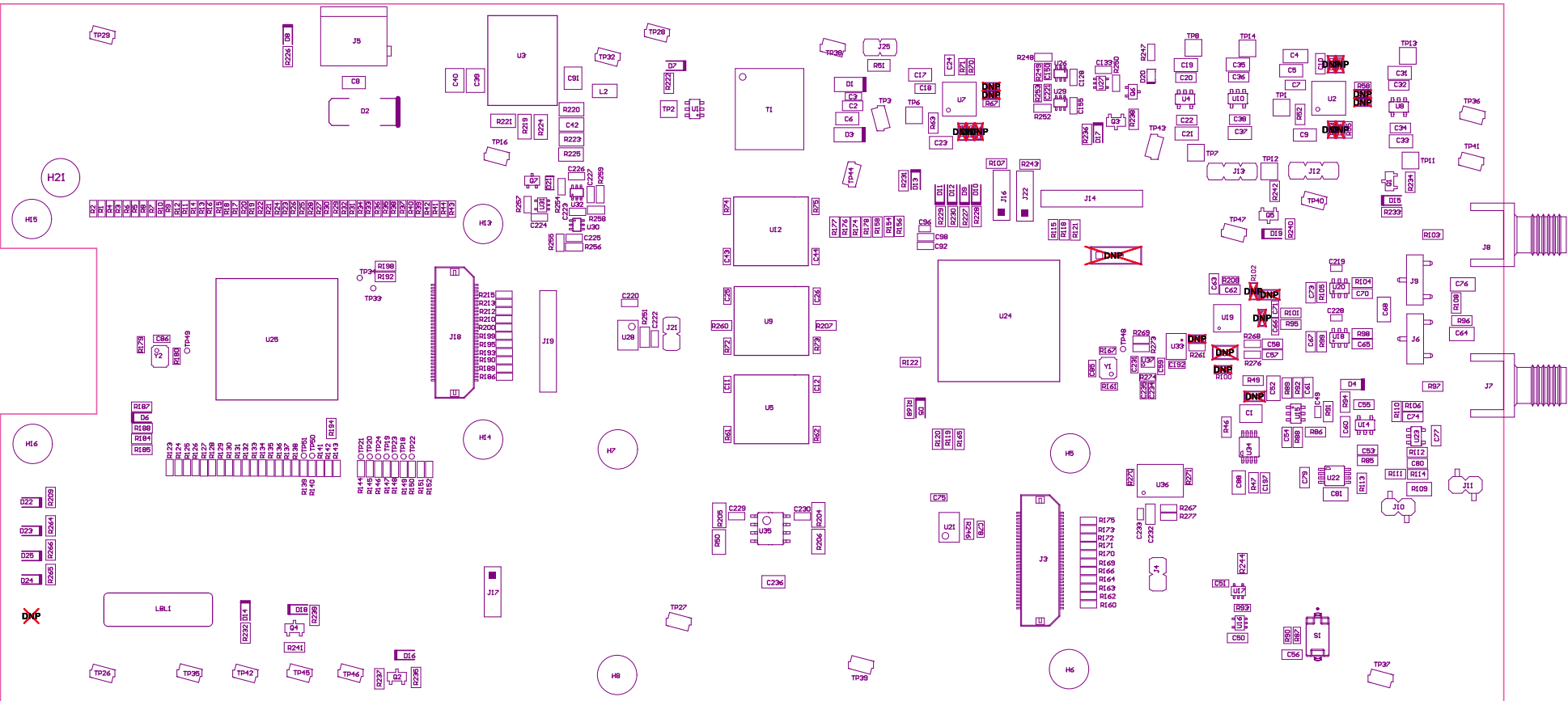
- Z21 ■ Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.
- Z22 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.
- Z23 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- Z24 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



COMPONENTS MARKED 'DNE' SHOULD NOT BE POPULATED.

ASSEMBLY VARIANT: A099110 w-REF9045

PCB VIEWED FROM TOP SIDE	BOARD #:	TIDA-00732	REV:	E1	SUN REV:
IGNORE ->	ASSEMBLY TOP	TID #:	TIDA-00732		
PLOT NAME =	Top Assembly Drawing	GENERATED :	02/10/2015	12:12:36 PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNE' SHOULD NOT BE POPULATED.

ASSEMBLY VARIANT:

ADSS110 w/REF5045

PCB VIEWED FROM BOTTOM SIDE	BOARD #:	TIDA-00732	REV:	E1	SUN REV:
	TID #:	TIDA-00732	IGNORE ->	ASSEMBLY BOTTOM	
PLOT NAME =	Bottom Assembly Drawing	GENERATED :	02-10-2015	12:12:36 PM	TEXAS INSTRUMENTS

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